



## AO4438

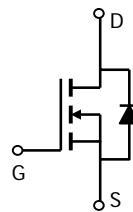
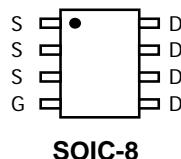
### N-Channel Enhancement Mode Field Effect Transistor

#### General Description

The AO4438 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4438 is Pb-free (meets ROHS & Sony 259 specifications). AO4438L is a Green Product ordering option. AO4438 and AO4438L are electrically identical.

#### Features

$V_{DS}$  (V) = 60V  
 $I_D$  = 8.2A ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 22m\Omega$  ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 27m\Omega$  ( $V_{GS}$  = 4.5V)



#### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>A</sup>	$I_D$	8.2	A
$T_A=70^\circ C$		6.6	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	40	
Power Dissipation	$P_D$	3.1	W
$T_A=70^\circ C$		2	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

#### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	24	40	°C/W
Steady-State		54	75	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	21	30	°C/W

**N Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	60			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=48\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	2.2	3	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	40			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=8.2\text{A}$ $T_J=125^\circ\text{C}$		16.3 30	22 40	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=7.6\text{A}$			20 27	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=8.2\text{A}$		24		S
$V_{SD}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.74	1	V
$I_S$	Maximum Body-Diode Continuous Current				3	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$		1920	2300	pF
$C_{oss}$	Output Capacitance			155		pF
$C_{rss}$	Reverse Transfer Capacitance			116		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		0.65	0.8	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, I_D=8.2\text{A}$		47.6	58	nC
$Q_g(4.5\text{V})$	Total Gate Charge			24.2	30	nC
$Q_{gs}$	Gate Source Charge			6		nC
$Q_{gd}$	Gate Drain Charge			14.4		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, R_L=3.6\Omega, R_{\text{GEN}}=3\Omega$		8.2		ns
$t_r$	Turn-On Rise Time			5.5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			29.7		ns
$t_f$	Turn-Off Fall Time			5.2		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=8.2\text{A}, dI/dt=100\text{A}/\mu\text{s}$		34	41	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=8.2\text{A}, dI/dt=100\text{A}/\mu\text{s}$		53		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

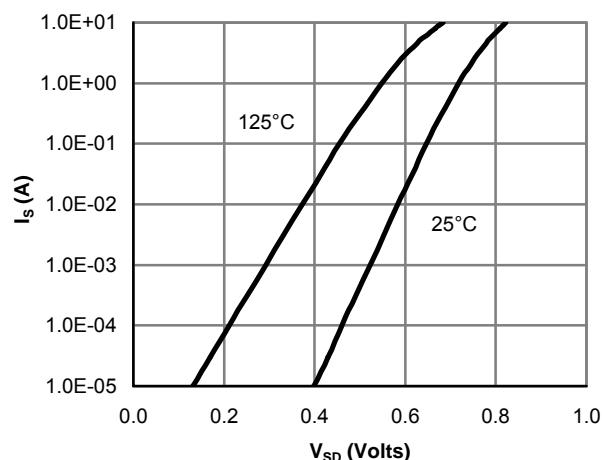
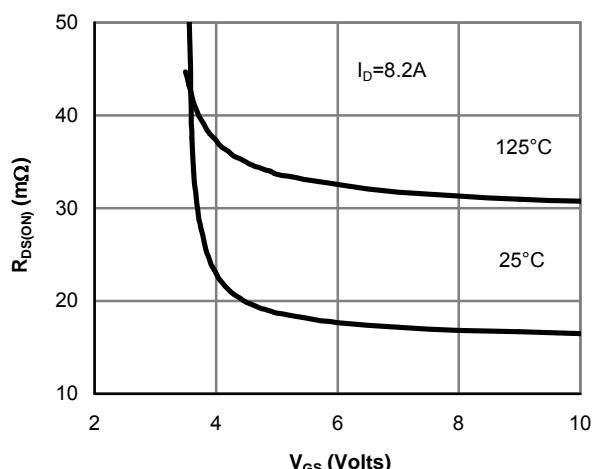
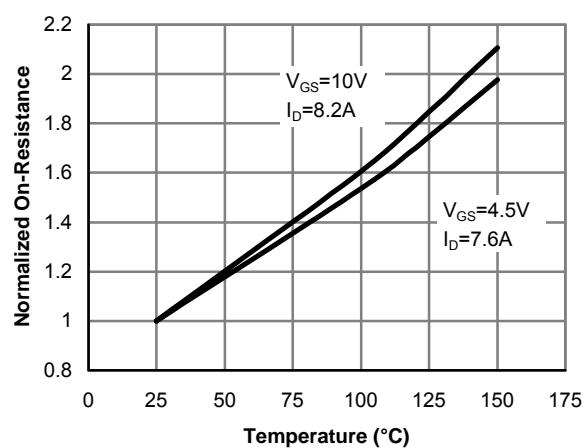
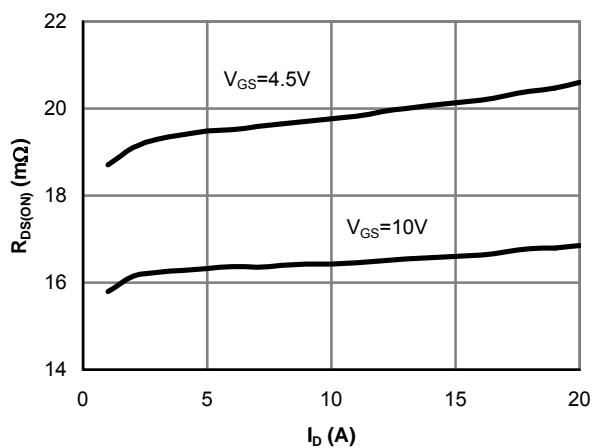
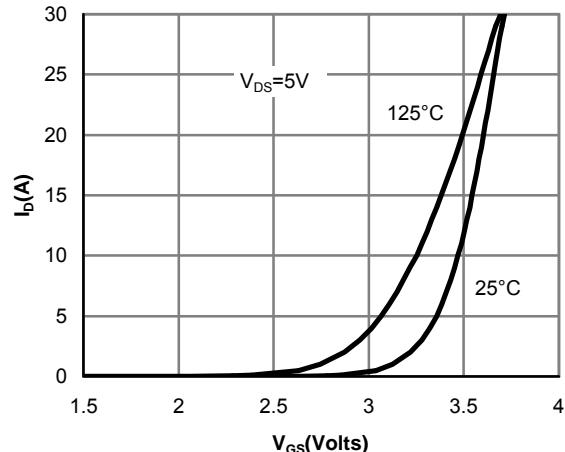
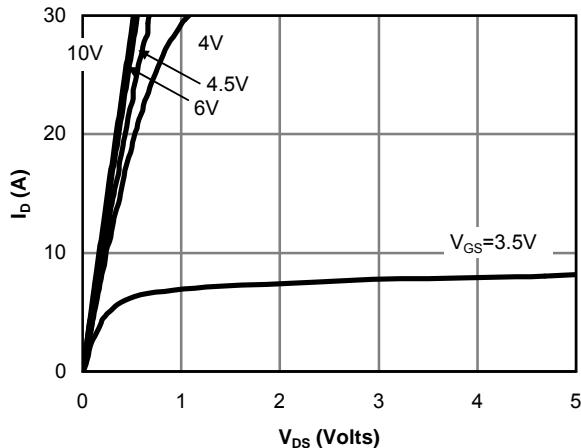
D. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: N-CHANNEL



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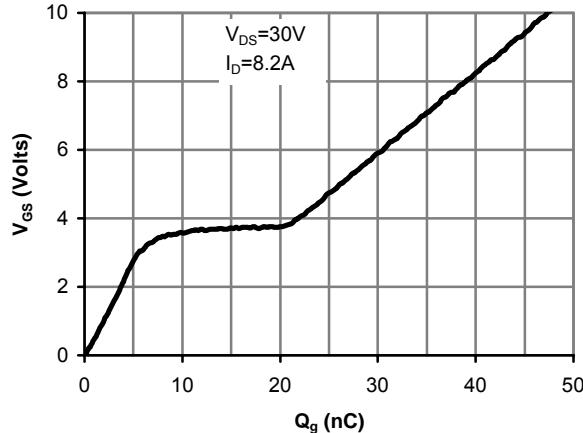


Figure 7: Gate-Charge Characteristics

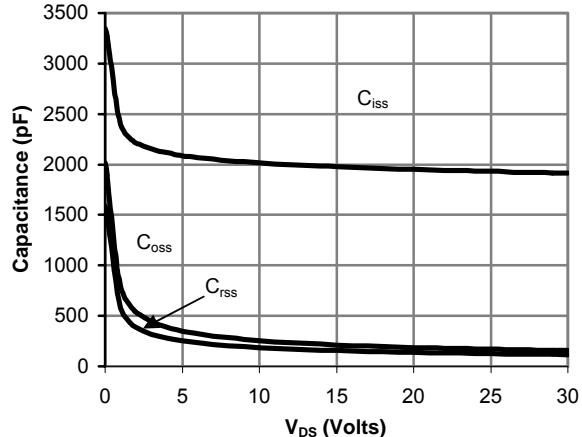


Figure 8: Capacitance Characteristics

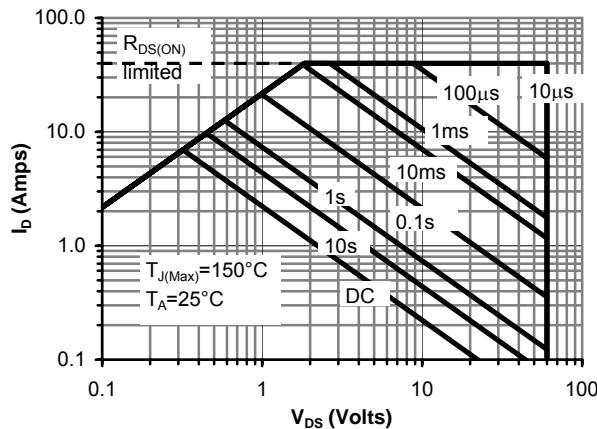


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

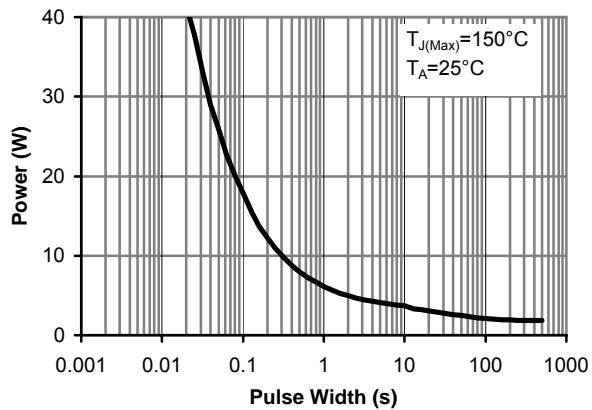


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

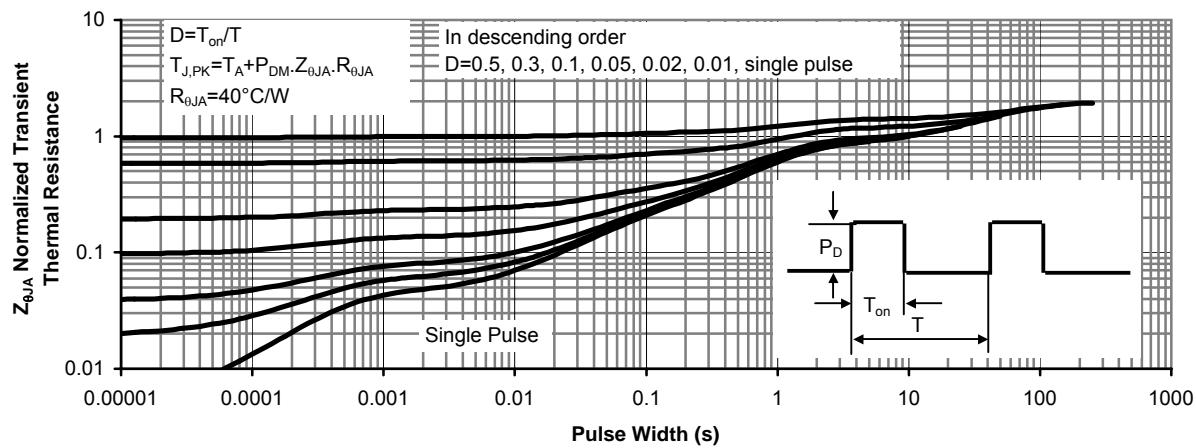


Figure 11: Normalized Maximum Transient Thermal Impedance